





0.5A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

Features

- Low Forward Voltage Drop
- Guard Ring Die Construction for Transient Protection
- High Conductance
- Lead, Halogen and Antimony Free, RoHS Compliant "Green" Device (Notes 3 and 4)

Mechanical Data

Case: SOD-123

 Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0

Moisture Sensitivity: Level 1 per J-STD-020D

 Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe) Solderable per MIL-STD-202, Method 208

· Polarity: Cathode Band

Marking Information: See Page 3
Ordering Information: See Page 3
Weight: 0.01 grams (approximate)



Top View

Maximum Ratings @T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	30	V
RMS Reverse Voltage		V _{R(RMS)}	21	V
Average Rectified Output Current @ -	T _L = 100°C	lo	0.5	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load		I _{FSM}	5.5	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 1)	P _D	410	mW
Typical Thermal Resistance Junction to Ambient (Note 1)	$R_{ heta JA}$	244	°C/W
Operating and Storage Temperature Range	$T_{J_i} T_{STG}$	-65 to +125	°C

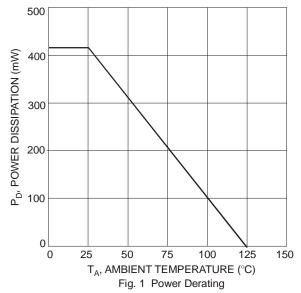
Electrical Characteristics @T_A = 25°C unless otherwise specified

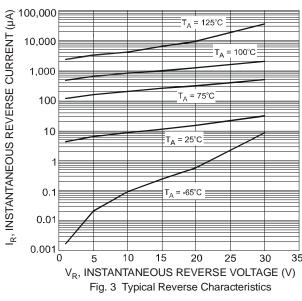
Characteristic	Symbol	Value	Unit	Test Conditions
Minimum Reverse Breakdown Voltage (Note 2)	$V_{(BR)R}$	30	V	I _R = 130μA
Maximum Forward Voltage Drop	V _{FM}	0.375 0.430	V	I _F = 0.1A, T _J = 25°C I _F = 0.5A, T _J = 25°C
Maximum Leakage Current (Note 2)	I _{RM}	20 130	μΑ	$V_R = 15V, T_J = 25$ °C $V_R = 30V, T_J = 25$ °C
Total Capacitance	Ст	170	pF	$f = 1MHz, V_R = 0V DC$

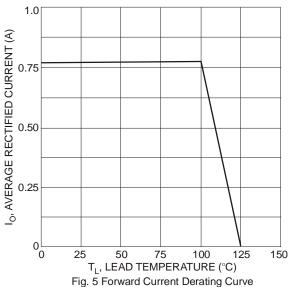
Notes:

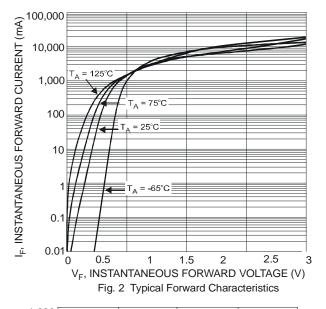
- 1. Device mounted on FR-4 PC board, 2"x2", 2 oz. Copper, single sided, Cathode pad dimensions 0.75"x1.0", Anode pad dimensions 0.25"x1.0".
- 2. Pulse Test: Pulse width = $300\mu s$, Duty Cycle $\leq 2\%$.
- 3. No purposefully added lead. Halogen and Antimony Free.
- 4. Product manufactured with Data Code V9 (week 33, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date Code V9 are built with Non-Green Molding Compound and may contain Halogens or Sb₂O₃ Fire Retardants.

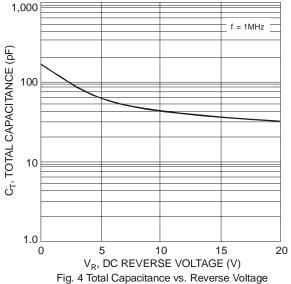












June 2008

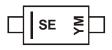


Ordering Information (Note 5)

Part Number	Case	Packaging
B0530W-7-F	SOD-123	3000/Tape & Reel

Notes: 5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



SE = Product Type Marking Code

YM = Date Code Marking

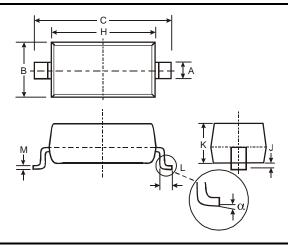
Y = Year (ex: N = 2002)

M = Month (ex: 9 = September)

Date Code Key

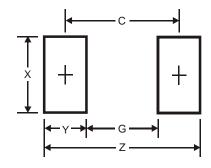
Year	1998	1999	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	J	K	L	M	N	Р	R	S	Т	U	V	W	X	Υ	Z
Month	Jan	Fe	b	Mar	Apr	May	Ju	n	Jul	Aug	Sep	Ос	t I	Nov	Dec
Code	1	2		3	4	5	6		7	8	9	0		N	D

Package Outline Dimensions



SOD-123					
Dim	Min Max				
Α	0.55	Тур			
В	1.40	1.70			
С	3.55 3.85				
Н	2.55 2.85				
J	0.00 0.10				
K	1.00 1.35				
L	0.25 0.40				
M	M 0.10 0.15				
α	0	8°			
All Dimensions in mm					

Suggested Pad Layout



Dimensions	Value (in mm)
Z	4.9
G	2.5
Х	0.7
Υ	1.2
С	3.7

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